

| | | | | |
|-----------------------------------|---------------------------------------|--|---|-------------|
| Notice of References Cited | Application/Control No. 10/566,769 | | Applicant(s)/Patent Under Reexamination BOYD ET AL. | |
| | Examiner DUNG BUI | | Art Unit 1797 | Page 1 of 1 |

U.S. PATENT DOCUMENTS

| * | | Document Number Country Code-Number-Kind Code | Date MM-YYYY | Name | Classification |
|---|---|--|-----------------|--------------------|----------------|
| * | A | US-4,385,726 A | 05-1983 | Bernauer et al. | 237/12.3C |
| * | B | US-5,753,383 A | 05-1998 | Cargnelli et al. | 429/13 |
| * | C | US-2001/0039803 A1 | 11-2001 | Stetson et al. | 62/46.2 |
| * | D | US-6,591,616 B2 | 07-2003 | Ovshinsky et al. | 62/46.2 |
| * | E | US-6,627,340 B1 | 09-2003 | Ovshinsky et al. | 429/20 |
| * | F | US-2006/0003193 A1 | 01-2006 | Stabler et al. | 429/009 |
| * | G | US-2007/0169852 A1 | 07-2007 | Inoue et al. | 148/403 |
| * | H | US-7,306,780 B1 | 12-2007 | Kravitz et al. | 423/648.1 |
| * | I | US-2007/0297964 A1 | 12-2007 | Soloveichik et al. | 423/286 |
| * | J | US-2007/0289882 A1 | 12-2007 | Myasnikov et al. | 206/6 |
| * | K | US-7,405,013 B2 | 07-2008 | Yang et al. | 429/13 |
| | L | US- | | | |
| | M | US- | | | |

FOREIGN PATENT DOCUMENTS

| * | | Document Number Country Code-Number-Kind Code | Date MM-YYYY | Country | Name | Classification |
|---|---|--|-----------------|---------|------|----------------|
| | N | | | | | |
| | O | | | | | |
| | P | | | | | |
| | Q | | | | | |
| | R | | | | | |
| | S | | | | | |
| | T | | | | | |

NON-PATENT DOCUMENTS

| * | | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
|---|---|---|
| | U | |
| | V | |
| | W | |
| | X | |

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.